

FEATURES

- Low losses for high efficiency
- Hermetically sealed for long operational life
- Easily mounted down with 4 M8 bolts on 46mm centres
- Available with flying lead, full and half bar connections on request
- Available anode to base and cathode to base
- Selections available for parallel operation

KEY PARAMETERS

| | |
|-------------|--------------|
| V_{RRM} | 6000V |
| $I_{F(AV)}$ | 412A |
| I_{FSM} | 8500A |

VOLTAGE RATINGS

| Part and Ordering Number | Repetitive Peak Voltages V_{RRM} V | Conditions |
|--------------------------|--------------------------------------|----------------------------|
| S1112SXU60 to S1112SXU40 | 6000 to 4000 | $V_{RSM} = V_{RRM} + 100V$ |

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

S1112SXU60 for a 6000V anode to base device
S1112SXD60 for a 6000V cathode to base device

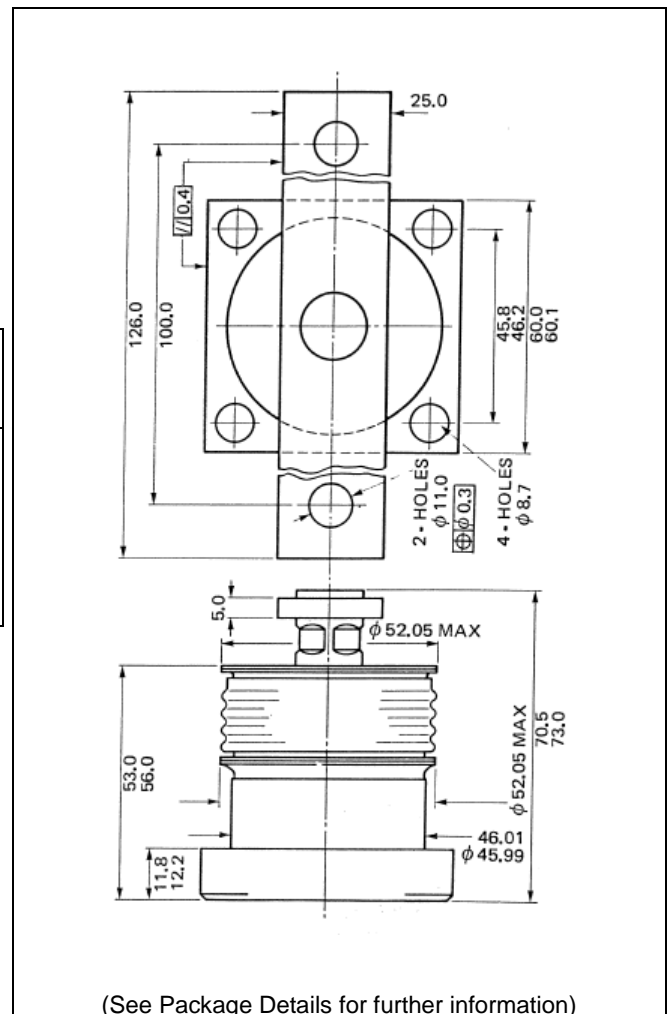


Fig. 1 Package outline

CURRENT RATINGS

$T_{case} = 100^{\circ}\text{C}$ unless stated otherwise

| Symbol | Parameter | Test Conditions | Max. | Units |
|--|--------------------------------------|--------------------------|------|-------|
| Single Side Cooled (Anode side) | | | | |
| $I_{F(AV)}$ | Mean forward current | Half wave resistive load | 412 | A |
| $I_{F(RMS)}$ | RMS value | - | 648 | A |
| I_F | Continuous (direct) on-state current | - | 532 | A |

SURGE RATINGS

| Symbol | Parameter | Test Conditions | Max. | Units |
|-----------|---|--|-------|-----------------------|
| I_{FSM} | Surge (non-repetitive) on-state current | 10ms half sine, $T_{case} = 150^{\circ}\text{C}$ | 8.5 | kA |
| I^2t | I^2t for fusing | $V_R = 50\% V_{RRM} - \frac{1}{4}$ sine | 0.361 | MA^2s |

THERMAL AND MECHANICAL RATINGS

| Symbol | Parameter | Test Conditions | Min. | Max. | Units |
|---------------|---|-----------------------|------|-------|----------------------|
| $R_{th(j-c)}$ | Thermal resistance – junction to heatsink | dc | - | 0.065 | $^{\circ}\text{C/W}$ |
| | | Half wave | | 0.065 | $^{\circ}\text{C/W}$ |
| | | 3 phase | | 0.078 | $^{\circ}\text{C/W}$ |
| T_{vj} | Virtual junction temperature | On-state (conducting) | - | 150 | $^{\circ}\text{C}$ |
| | | Reverse (blocking) | - | 150 | $^{\circ}\text{C}$ |
| T_{sig} | Storage temperature range | | -55 | 165 | $^{\circ}\text{C}$ |
| Torque | Clamping torque | | 0 | 22 | Nm |

CHARACTERISTICS

| Symbol | Parameter | Test Conditions | Min. | Max. | Units |
|----------|-------------------------------|--|------|-------|-----------|
| V_{FM} | Forward voltage | At 1800A peak, $T_{case} = 150^{\circ}C$ | - | 2.6 | V |
| I_{RM} | Peak reverse current | At V_{DRM} , $T_{case} = 150^{\circ}C$ | - | 75 | mA |
| Q_S | Total stored charge | $I_F = 1000A$, $dI_{RR}/dt = 3A/\mu s$ | - | 3000 | μC |
| I_{rr} | Peak reverse recovery current | $T_{case} = 150^{\circ}C$, $V_R = 100V$ | - | 85 | A |
| V_{TO} | Threshold voltage | At $T_{vj} = 150^{\circ}C$ | - | 0.97 | V |
| r_T | Slope resistance | At $T_{vj} = 150^{\circ}C$ | - | 0.872 | $m\Omega$ |

CURVES

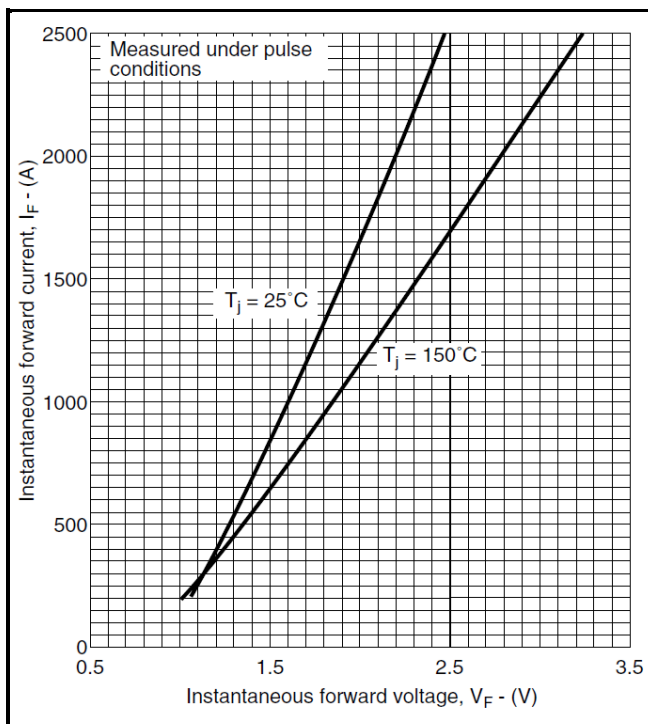


Fig.2 Maximum & minimum on-state characteristics

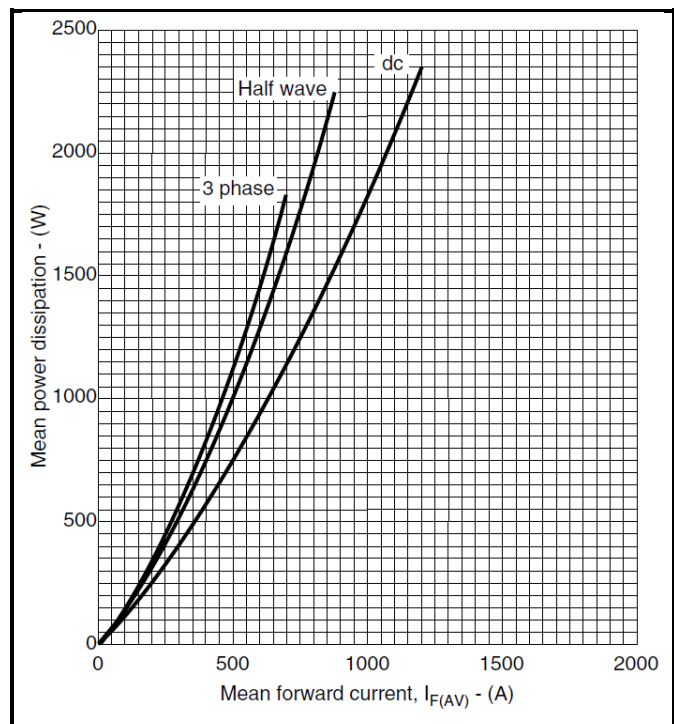


Fig.3 Dissipation curves

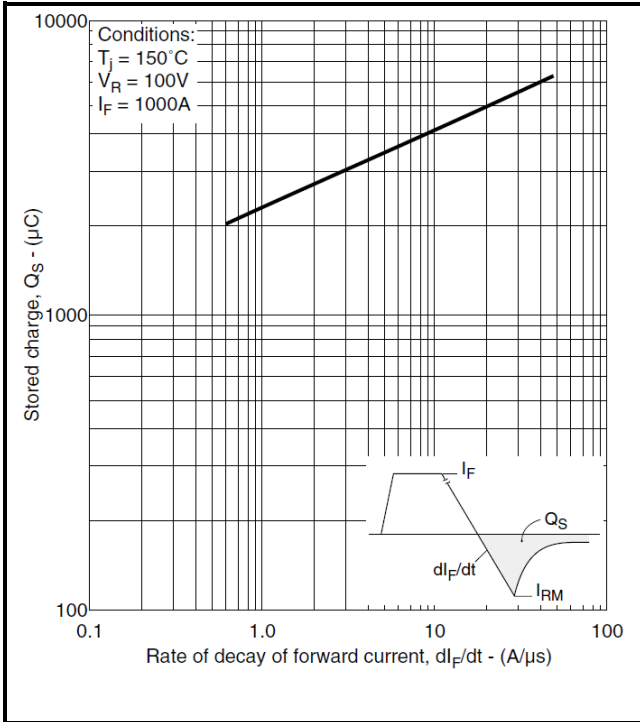


Fig.4 Total stored charge

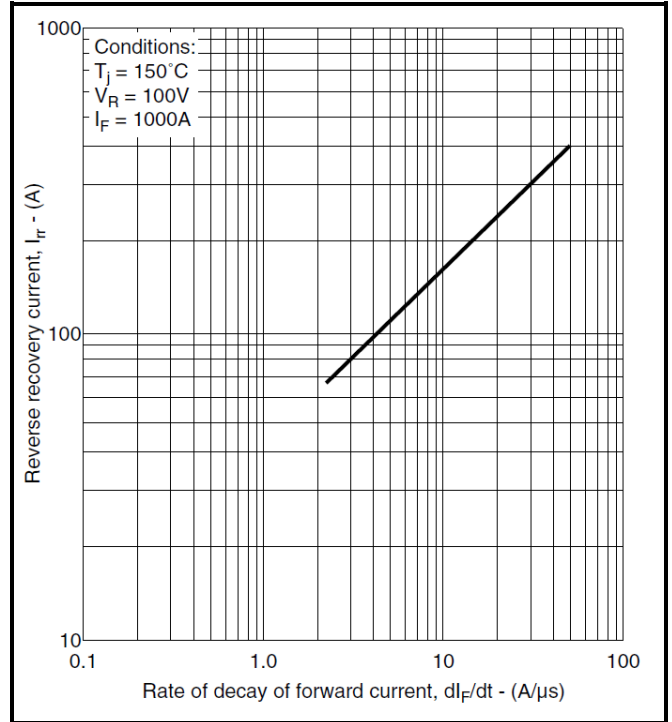


Fig.5 Maximum reverse recovery current

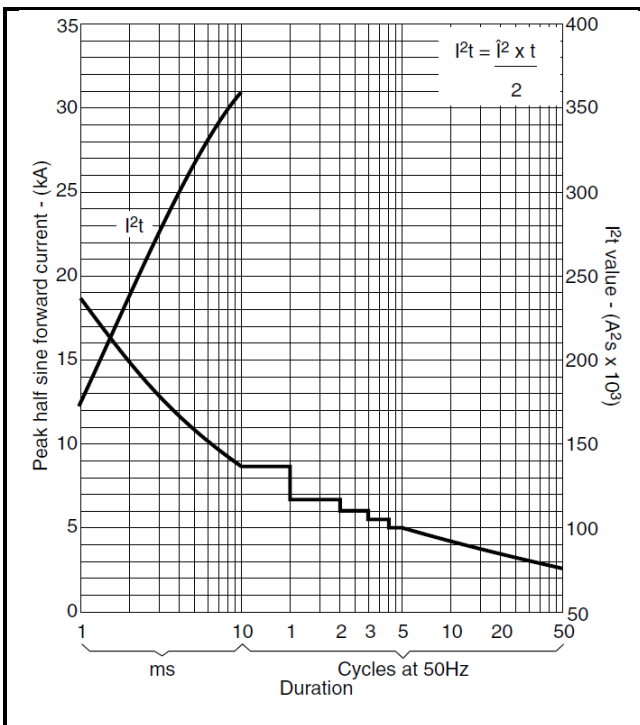


Fig.5 Surge (Non-Repetitive) Forward current vs time

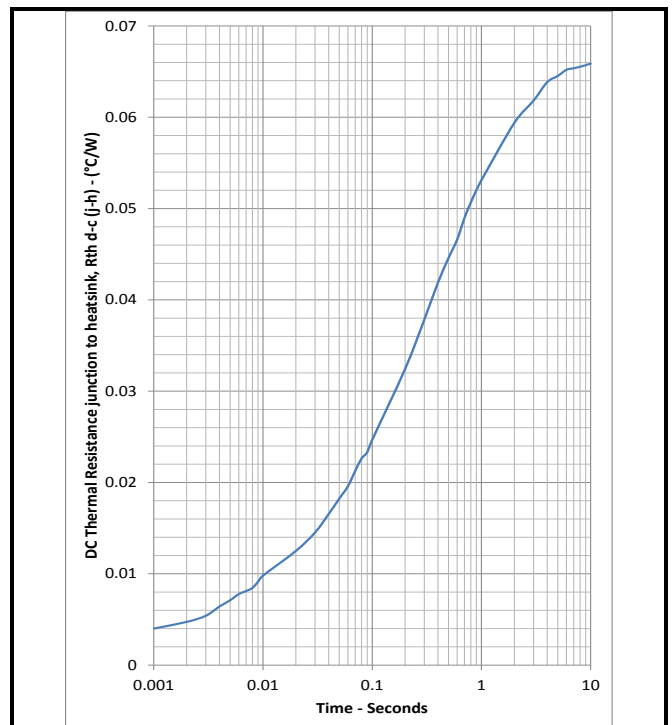
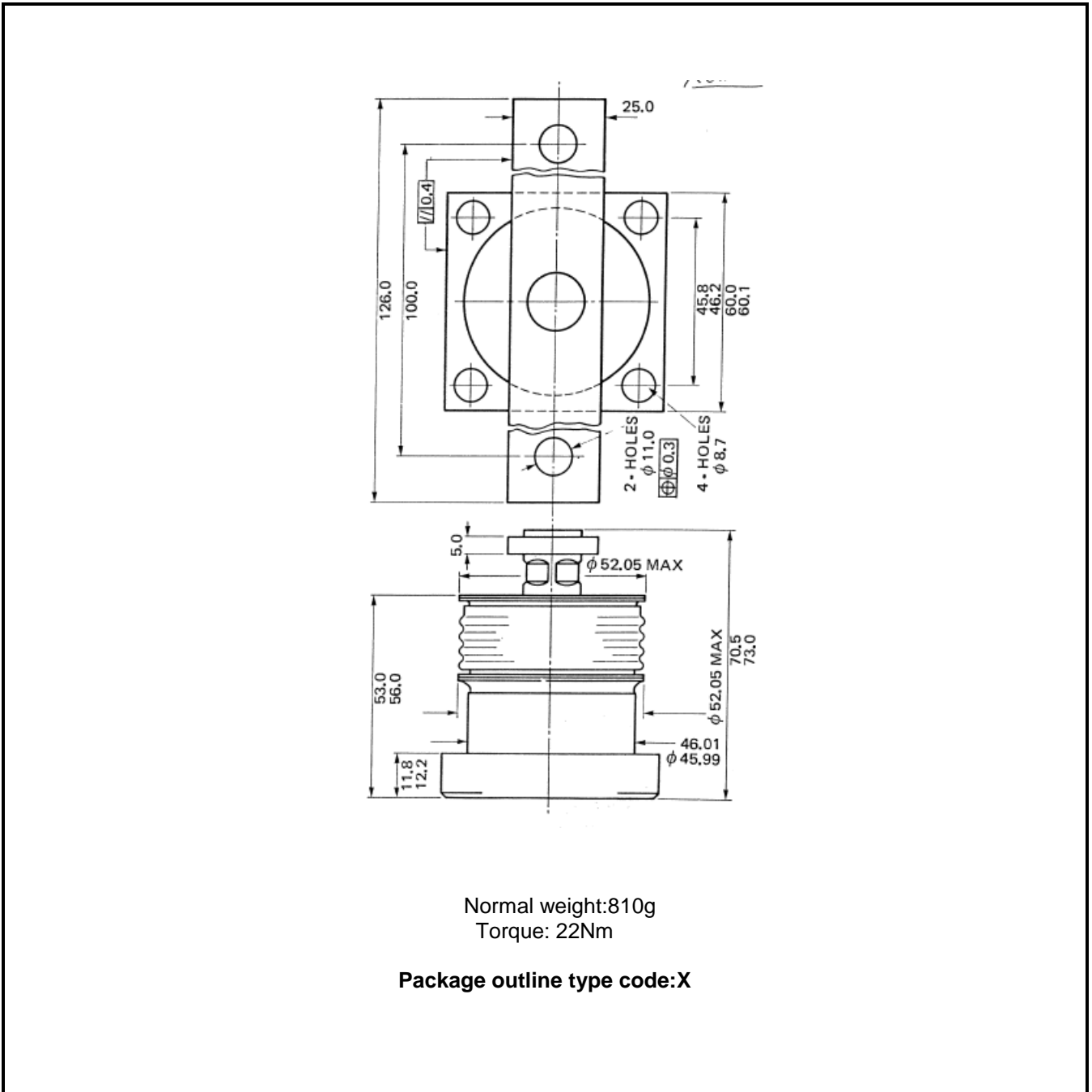


Fig.7 Maximum (limit) transient thermal impedance-junction to heatsink

PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



Note:
Some packages may be supplied with gate and or tags.

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| | |
|---------------------------------|---|
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